User's Manual



IE-703037-MC-EM1

In-circuit Emulator Option Board

Target device V850/SB1™

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INTRODUCTION

Target Readers	This manual is intended for users who design and develop application systems using the V850/SB1 ^{TM} .		
Purpose	The purpose of this manual is to describe the proper operation of the IE-703037-MC- EM1 and its basic specifications.		
Organization	This manual is divided into the following parts.OverviewNames and functions of componentsCautions		
How to Read This Manual	It is assumed that the reader of this manual has general knowledge in the fields of electrical engineering, logic circuits, and microcontrollers. The IE-703037-MC-EM1 is used connected to the IE-703002-MC in-circuit emulato This manual explains the basic setup procedure and switch settings of the IE 703002-MC when it is connected to the IE-703037-MC-EM1. For the names an functions of parts, and the connection of elements, refer to the IE-703002-MC User' Manual. To learn about the basic specifications and operation methods → Read this manual in the order of the CONTENTS . To learn the operation methods and command functions, etc., of the IE-703002-MC and IE-703037-MC-EM1		
Conventions	Note: Caution: Remark: Numeral represer	 Footnote for item marked with Note in the text Information requiring special attention Supplementary information ntation: Binary ··· xxxx or xxxxB Decimal ··· xxxx Hexadecimal ··· xxxxH an exponent of 2 (address space, memory capacity): K (kilo): 2¹⁰ = 1024 	
Terminology	The meanings of Target device Target system	K (Kilo). 2 = 1024 M (mega): 2 ²⁰ = 1024 ² terms used in this manual are listed below. The device that is targeted for emulation. The system (user-built system) that is targeted for debugging. This includes the target program and user-configured hardware.	

Related Documents

When using this manual, refer to the following manual.

The related documents indicated in this publication may include preliminary versions. However, preliminary versions are not marked as such.

O Documents related to development tools (User's Manual)

Document	Document Number	
IE-703002-MC (In-circuit emulator)		U11595E
IE-703037-MC-EM1 (In-circuit emulator	option board)	This manual
CA850 (C Compiler package)	Operation UNIX [™] based	U12839E
	Operation Windows [™] based	U12827E
	C language	U12840E
	Assembly Language	U10543E
Project manager Windows-based		U11991E
ID850 (Integrated debugger) Operation Windows-based		U13716E
RX850 (Real-time OS) Basics		U13430E
	Technical	U13431E
Installation		U13410E
RX850 Pro (Real-time OS)	Basics	U13773E
	Technical	U13772E
	U13774E	
RD850 (Task debugger) ^{№te}	U11158E	
RD850 (Ver.3.0) (Task debugger)	U13737E	
AZ850 (System performance analyzer)	U11181E	

Note For ID850 (Ver. 1.31 only)

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CHAPTER 1 OVERVIEW

The IE-703037-MC-EM1 is an option board for the IE-703002-MC in-circuit emulator. By connecting the IE-703037-MC-EM1 and IE-703002-MC, hardware and software can be debugged efficiently in system development using the V850/SB1.

In this manual, the basic setup procedure and switch settings of the IE-703002-MC when using the IE-703037-MC-EM1 are described. For the names and functions of the parts of the IE-703002-MC, and for the connection of elements, refer to the **IE-703002-MC User's Manual**.

1.1 Hardware Configuration

circuit emulator (IE-703002-MC)		
Option board	By adding this board, the IE-703002-MC can be used as in-circuit	
(IE-703037-MC-EM1)	emulator for V850/SB1.	
	Optional hardware	
	Optional nationale	
Extension probe (SC-100SD ^{Note 1})	General-purpose extension probe made by TOKYO ELETECH CORPORATION	
PC interface board	This board is used to connect the IE-703002-MC to a personal compu	
(IE-70000-xx-IF-B	This board is inserted in the expansion slot of the personal computer.	
IE-70000-xx-IF-C IE-70000-PCI-IF	xx: 98 (for PC-9800 series C bus) ^{№ee 2} xx: PC (for IBM PC/AT [™] or compatibles ISA bus) ^{№ee 2}	
(IE-70000-CD-IF-A	IE-70000-PCI-IE: for PCI bus	
	IE-70000-CD-IF-A: for PCMCIA socket	
Network module	This module is used when a workstation controls the IE-703002-MC v	
(IE-70000-MC-SV3)	an Ethernet™.	
Devene device		
Power adapter (IE-70000-MC-PS-B)	AC adapter for in-circuit emulator made by NEC Corporation.	

Notes 1. For further information, contact to Daimaru Kogyo Co., Ltd. Tokyo Electronics Department (TEL +81-3-3820-7112)

- Osaka Electronics Department (TEL +81-6-6244-6672)
- 2. Cannot be used for PC98-NX series

1.2 Features (When Connected to IE-703002-MC)

- O Maximum operating frequency: 20 MHz (at 3.3 to 5.0-V operation)
- O Extremely lightweight and compact
- O Higher equivalence with target device can be achieved by omitting buffer between signal cables.
- ${\rm O} \quad {\rm The \ following \ pins \ can \ be \ masked}.$
 - RESET, NMI, WAIT, HLDRQ
- O Two methods of connection to target system:
 - Pod tip direct connection (For information on the pod, refer to the IE-703002-MC User's Manual)
 - Attach an extension probe (sold separately) to the pod tip for connection
- O The dimensions of the IE-703037-MC-EM1 are as follows.

Parameter		Value	
Power consumption (Max. value at 3.3-V supply voltage)		0.35 W (at 20-MHz operation frequency) ^{Note}	
External dimensions Height		15 mm	
(Refer to APPENDIX PACKAGE DRAWINGS)	Length	194 mm	
Width		96 mm	
Weight		160 g	

Note 10.35 W when IE-703002-MC connected to IE-703037-MC-EM1

1.3 Function Specifications (When Connected to IE-703002-MC)

Parameter			Specification
Emulation memory capacity	Internal ROM		256 Kbytes
	External	In ROM-less mode	2 Mbytes
	memory	When using iROM	1 Mbyte
Execution/pass detection	Internal ROM		256 Kbytes
coverage memory capacity	External memory	In ROM-less mode	2 Mbytes
		When using iROM	1 Mbyte
Memory access detection coverage memory	/ capacity (externa	al memory)	1 Mbyte
Coverage memory capacity for branching	Internal ROM		256 Kbytes
entry number counting	External	In ROM-less mode	2 Mbytes
	memory	When using iROM	1 Mbyte

Caution Some of the functions may not be supported, depending on the debugger used.

1.4 System Configuration

The system configuration when connecting the IE-703002-MC to the IE-703037-MC-EM1 and a personal computer (PC-9800 series or PC/AT[™] (or compatibles)) is shown below.

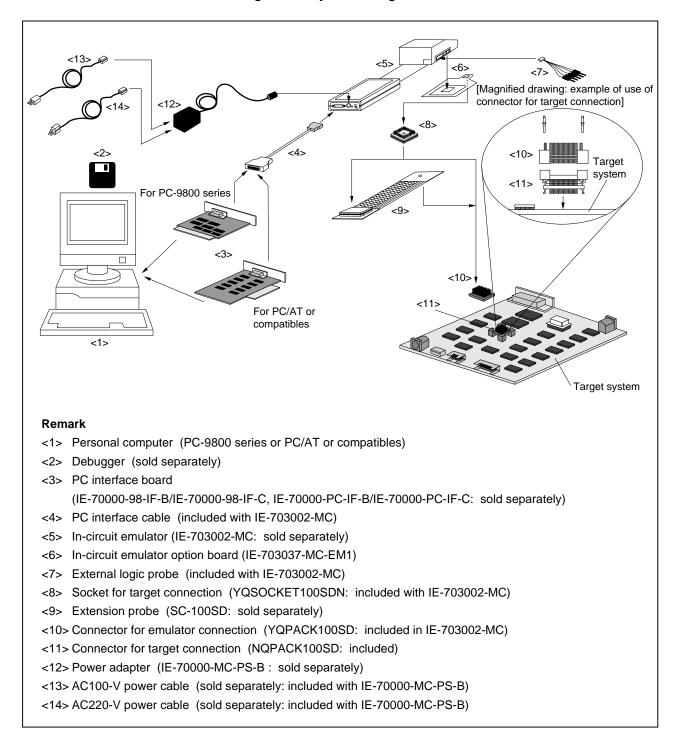


Figure 1-1. System Configuration

1.5 Contents in Carton

The carton of the IE-703037-MC-EM1 contains a main unit, guarantee card, packing list, and accessory bag. Make sure that the accessory bag contains this manual and the connector accessories. If there are missing or damaged items, please contact an NEC sales representative or an NEC distributor.

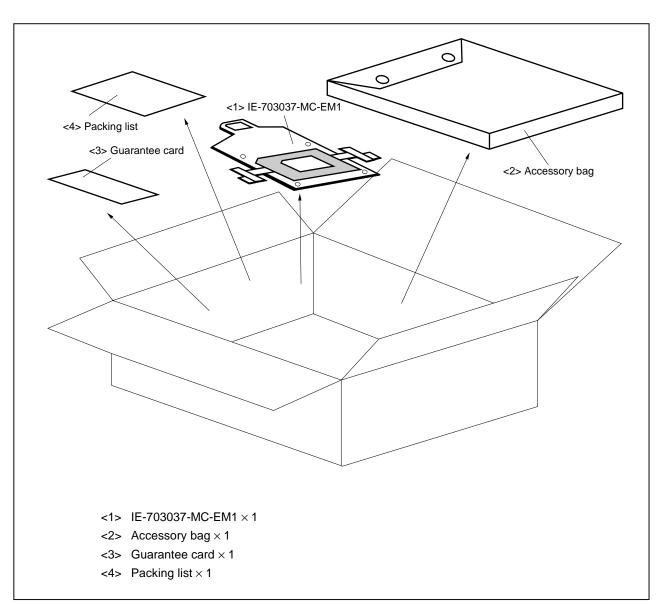
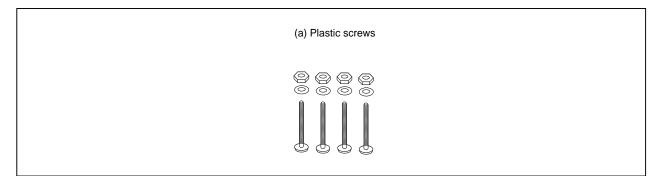


Figure 1-2. Contents in Carton

Check that the accessory bag contains this manual, an accessory list, and the following accessories.

(a) Plastic screws × 4(including nuts and washer × 4 sets)

Figure 1-3. Accessories



1.6 Connection between IE-703002-MC and IE-703037-MC-EM1

The procedure for connecting the IE-703002-MC and IE-703037-MC-EM1 is described below.

Caution Connect carefully so as not to break or bend connector pins.

- <1> Remove the pod cover (upper and lower) of the IE-703002-MC.
- <2> Set the PGA socket lever of the IE-703037-MC-EM1 to the OPEN position as shown in Figure 1-4 (b).
- <3> Connect the IE-703037-MC-EM1 to the PGA socket at the back of the IE-703002-MC pod (refer to Figure 1-4 (c)). When connecting, position the IE-703002-MC and IE-703037-MC-EM1 so that they are horizontal.
- <4> Set the PGA socket lever of the IE-703037-MC-EM1 to the CLOSE position as shown in Figure 1-4 (b).
- <5> Set the IE-703002-MC pod jumpers (JP1 to JP4).

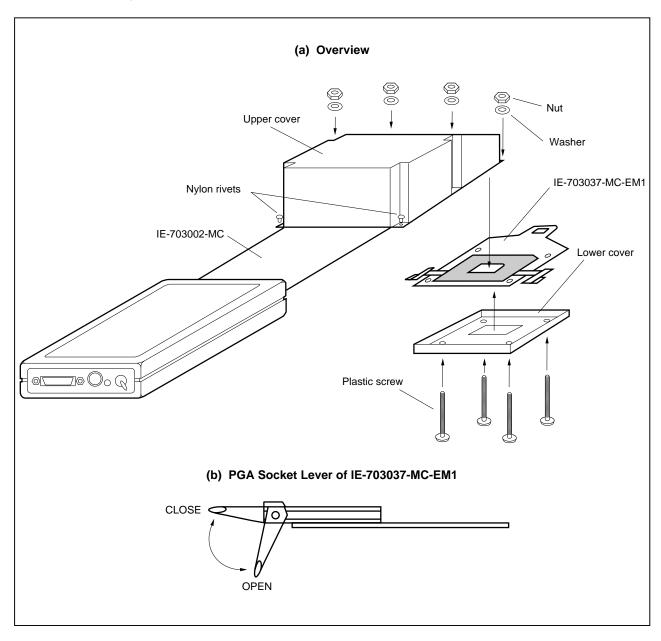
Open JP1 (Remove the jumper contact and attach the removed jumper contact to one of the jumper pins to avoid losing it.)

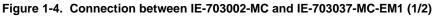
Retain the factory settings of JP2 (pins 1 and 2 shorted, and pins 5 and 6 shorted). Short pins 1 and 2 of JP3.

Retain the factory settings of JP4 (pins 2 and 3 shorted).

- <6> Fix the IE-703037-MC-EM1 between the IE-703002-MC pod covers (upper and lower) with the plastic screws (supplied with the IE-703002-MC).
- <7> Fix the IE-703002-MC pod cover (upper) end with nylon rivets.

Remark For the JP1 setting, refer to 2.3 Illegal Access Detection ROM Setting. For JP3 and JP4, refer to 2.4 CPU Operation Voltage Range Switch Setting.





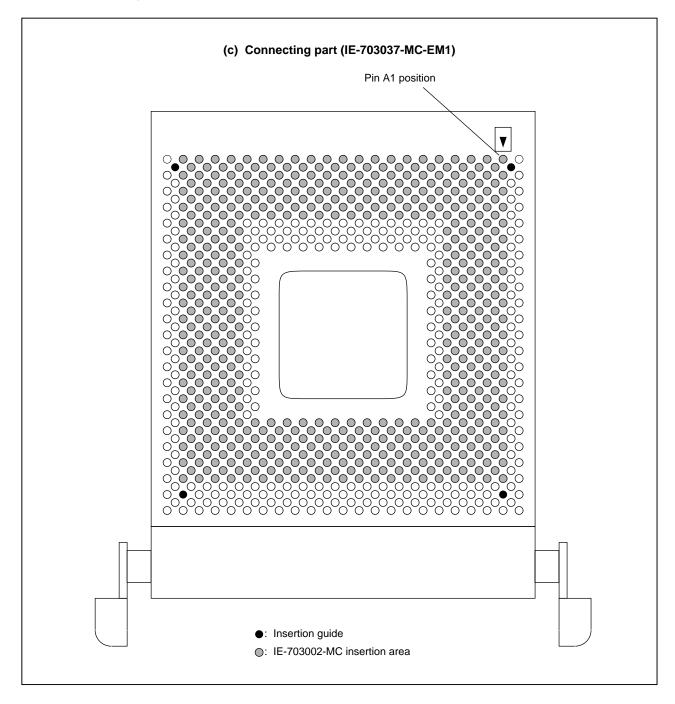
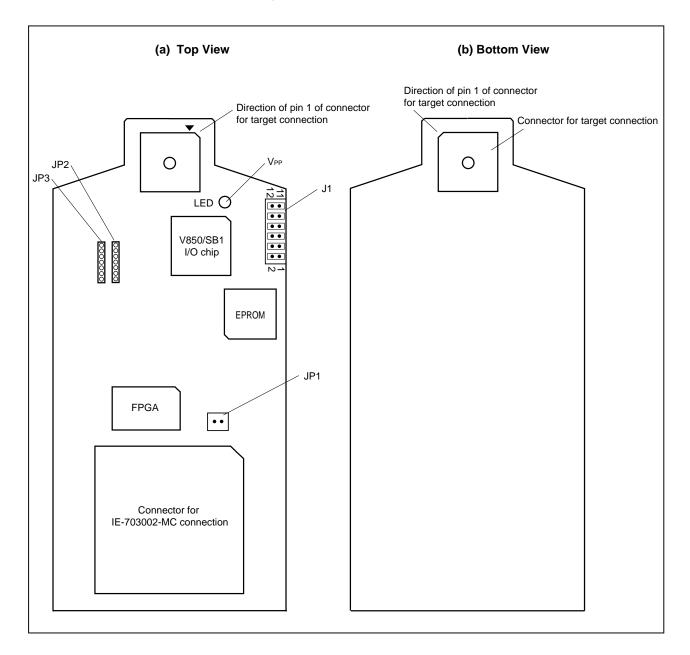


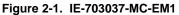
Figure 1-4. Connection between IE-703002-MC and IE-703037-MC-EM1 (2/2)

CHAPTER 2 NAMES AND FUNCTIONS OF COMPONENTS

This chapter describes the names, functions, and switch settings of components in the IE-703037-MC-EM1. For the details of the pod, jumper, and switch positions, etc., refer to the **IE-703002-MC User's Manual**.

2.1 Component Names and Functions of IE-703037-MC-EM1





(1) JP1

This is the jumper switch for product check. Leave open.

(2) JP2

This is the switch jumper of the main system clock supply source. (For details, refer to 2.2 Clock Settings)

(3) JP3

This is a pin board for supplying the subsystem clock. (For details, refer to 2.2 Clock Settings)

(4) LED

LED for VPP ON: Voltage is applied to VPP

OFF: Voltage is not applied to VPP

(5) Connector for IE-703002-MC connection

This is a connector for connecting with the IE-703002-MC.

(6) Connector for target connection

This is a connector for connecting with the target system or the extension probe.

2.2 Clock Settings

This section describes the clock settings.

For JP1 and JP2 position in the IE-703037-MC-EM1, refer to Figure 2-1.

For the jumper switch position in the IE-703002-MC, refer to the IE-703002-MC User's Manual.

2.2.1 Main system clock setting

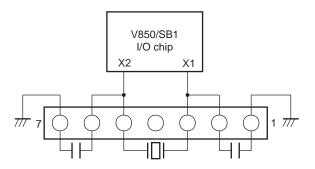
Table 2-1.	Main S	ystem	Clock	Setting
------------	--------	-------	-------	---------

Emulator Use	Clock Supply Method	IE-703037-MC-EM1 Setting		IE-7	03002-MC Setting
Environment		JP2	SW1	SW2	JP2
When using emulator as standalone unit	Internal clock ^{Note 1}	Oscillator mounted (a 20- MHz oscillator is mounted when shipped) Note 2		$\begin{array}{c} 7 \\ 8 \end{array} \begin{array}{c} \bullet \end{array} \begin{array}{c} \bullet \end{array} \begin{array}{c} \bullet \end{array} \begin{array}{c} \bullet \end{array} \begin{array}{c} 1 \\ \bullet \end{array} \begin{array}{c} \bullet \end{array} \begin{array}{c} \bullet \end{array} \end{array} \begin{array}{c} 2 \end{array}$	

Notes 1. A target clock is not supported.

2. To use a main system clock frequency other than 20 MHz, remove the oscillator on JP2 and mount any oscillator.

The specifications of JP2 are as follows.



2.2.2 Subsystem clock setting

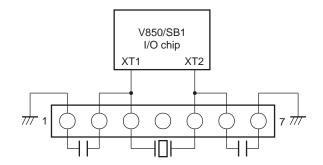
Table 2-2. Subsystem Clock Setting

Emulator Use	Clock Supply Method	IE-703037-MC-EM1 Setting
Environment		JP3
When using emulator as standalone unit	Internal clock ^{Note 1}	Oscillator mounted (a 32.768-kHz oscillator is mounted when shipped) $^{\mbox{\tiny Note 2}}$

Notes 1. A target clock is not supported. Internal clock does not support the clock input by oscillator.

2. To use a subsystem clock frequency other than 32.768 kHz, remove the oscillator on JP3 and mount any oscillator.

The specifications of JP3 are as follows.



2.3 Illegal Access Detection ROM Setting

If using the IE-703002-MC for an in-circuit emulator for the V850/SB1 by connecting the IE-703037-MC-EM1, set JP1 of the IE-703002-MC as follows.

Table 2-3.	JP1 Setting in IE-703002-MC
------------	-----------------------------

JI	21	Description			
Open ^{Note}	•	Illegal Access Detection ROM (mounted on IE-703037-MC-EM1) for V850/SB1 is used.			
	is set open, keep the n the drawing on the	e removed jumper contact attached to one pin			

2.4 CPU Operation Voltage Range Switching Setting

If using the IE-703002-MC for an in-circuit emulator for the V850/SB1 by connecting the IE-703037-MC-EM1, set JP3 and JP4 of the IE-703002-MC as follows.

JP3,	JP4
JP3	1 2
	(Short)
JP4	1
	2
	3

Table 2-4. JP3 and JP4 Setting in IE-703002-MC

Jumper contact

2.5 Separate Bus Function Setting

To use the separate bus function, J1 of the IE-703037-MC-EM1 must be set. Table 2-5 shows the correspondence between the MAM register and J1 settings.

MAM2	MAM1	MAM0	Operation of P34 to F	P36, P100 to P107, P110 to P113	J1 Setting
0	0	0	P34 to P36	Port mode	
			P100 to P107	Port mode	$\begin{array}{c} 2 \\ 1 \\ \end{array} \bigcirc 12 \\ 1 \\ \end{array} \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\$
			P110 to P113	Port mode	
0	1	0	P34 to P36	Port mode	
			P100 to P107	Port mode	$\begin{array}{c} 2 \\ 1 \end{array} \bigcirc 0 \\ 1 \end{array} \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc 0 \\ 1 \end{array} \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc 0 \\ 1 \end{array}$
			P110 to P113	A1 to A4	
0	1	1	P34 to P36	Port mode	
			P100 to P103	A5 to A8	2 • • • • • • • • • • • • • • • • • • •
			P104 to P107	Port mode	
			P110 to P113	A1 to A4	
1	0	0	P34 to P36	Port mode	
			P100 to P107	A5 to A12	$\begin{array}{c} 2 \\ 1 \end{array} \bigcirc 12 \\ 1 \end{array} \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc 0 \end{array} \bigcirc 11 $
			P110 to P113	A1 to A4	
1	0	1	P34	A13	
			P35, P36	Port mode	2 • • • • • 12
			P100 to P107	A5 to A12	
			P110 to P113	A1 to A4	
1	1	0	P34, P35	A13, A14	
			P36	Port mode	2 • • • • • 12
			P100 to P107	A5 to A12	
			P110 to P113	A1 to A4	
1	1	1	P34 to P36	A13 to A15	
			P100 to P107	A5 to A12	$\begin{array}{c c} 2 \\ 1 \\ \end{array} \bigcirc \bigcirc$
			P110 to P113	A1 to A4	

Table 2-5. MAM Register and J1 Setting Correspondence

CHAPTER 3 FACTORY SETTINGS

Item	Description	Remark		
JP1		Jumper switch for product check		
JP2	Oscillator mounted	20-MHz clock supplied for main system clock.		
JP3	Oscillator mounted	32.768-kHz clock supplied for subsystem clock.		
J1	$\begin{array}{c c} 2 \\ 1 \end{array} \begin{array}{c} 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 $	Set to port mode (P34 to P36, P100 to P107, P110 to P113)		

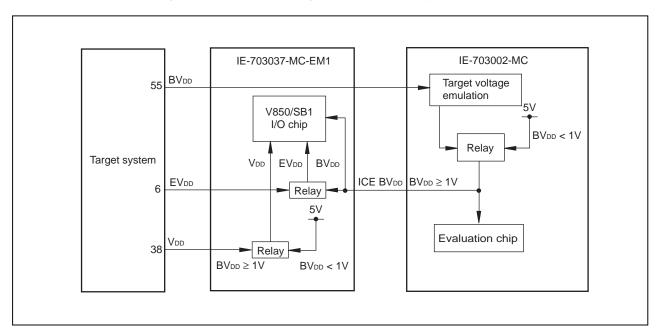
CHAPTER 4 CAUTIONS

4.1 VDD, BVDD, and EVDD of Target System

(1) BVbb in the target system is not connected to BVbb in the evaluation chip in the IE-703002-MC.

The IE-703002-MC uses $\mathsf{BV}_{\mathsf{DD}}$ of the target system for the following purposes:

- Power ON/OFF detection of target system
- BVDD emulation of target system
- (2) When the BV_{DD} voltage of the target system is 1 V or higher, the evaluation chip in the emulator operates using the supply of V_{DD} and EV_{DD} from the target system. The power consumption is equivalent to that of the V850/SB1.
- (3) When the BVDD voltage of the target system is lower than 1 V, the emulator recognizes the target system power is off and operates at VDD = BVDD = EVDD = 5.0 V.



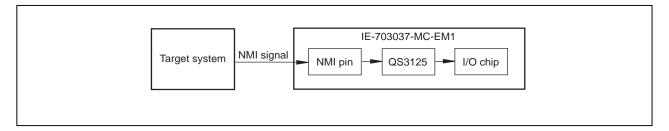


4.2 NMI Signal

The input signal (NMI signal) from the target system is delayed ($t_{pD} = 0.25$ ns (TYP.)) because it passes through QS3125 (Q switch) before it is input to the I/O chip of the emulator.

In addition, the DC characteristics change. The input voltage becomes V_{IH} = 2.0 V (MIN.), and V_{IL} = 0.8 V (MAX.). The input current becomes I_{IN} = $\pm 0.5 \mu$ A (MAX.).

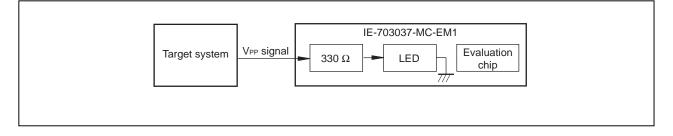




4.3 VPP Signal

The V_{PP} signal from the target system is connected to LED via a 330- Ω resistor in the emulator. It is not connected to the evaluation chip in the emulator.

Figure 4-3. VPP Signal Flow Path



4.4 MAM Register

Debugging of the MAM register cannot be performed in the emulator. If debugging the MAM register with software, proceed with care.

In the target device, ports can be used as address buses by setting values to the MAM register (address: FFFF068H), which is mapped in the internal peripheral I/O area, using software (separate bus function). In the emulator, however, switching to the separate bus through a MAM register setting by software is impossible.

To use the separate bus function, set the J1 jumper in advance. (Refer to 2.5 Separate Bus Function Setting)

4.5 NMI Signal Mask Function

When using the P00/NMI pin in the port mode, do not mask the NMI signal.

4.6 Bus Interface Pin

The operation of the pin for the bus interface differs between the emulator and the target device as follows.

Pin Name	Internal Memory								External Memory				
	Memory Used by Emulator		Internal Internal RAM ROM		Internal Peripheral I/O		Emulation RAM		Target System				
	F	R	W	R	R	W	R	W	R	W	R	W	
A16 to A21	Hold the last accessed address								Active		Active		
AD0 to AD15	Hi-Z	Hi-Z Active Active											
ASTB	Н								Active		Active		
R/W	н									Active		Active	
DSTB	н									н		Active	
LBEN	H Active									Active			
UBEN	н	H Active Active											
WAIT	Invalid	Invalid Maskable Maskable									le		
HLDRQ	Maskab	Maskable								Maskable		Maskable	
HLDAK	H or L	H or L								H or L		H or L	
WRL	н	н									н	Note	
WRH	Н								Н		Н	Note	
RD	н	Н									Note	Н	

Table 4-1. Bus Interface Pin Operation List (1/2)(a) During break

Note Active

Remarks 1. F: Fetch

- R: Read
- W: Write
- 2. H: High-level output
 - L: Low-level output
 - Hi-Z: High-impedance

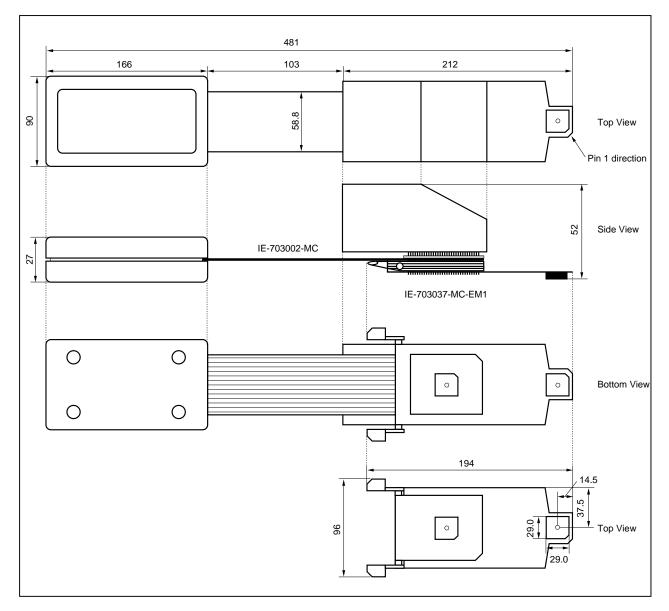
Pin	Internal Memory							External Memory					
Name	Interna	I ROM	In	ternal RA	M		ernal eral I/O	Emulation RAM		AM	Target System		
	F	R	F	R	W	R	W	F	R	W	F	R	W
A16 to A21	Hold the last accessed address										Active		
AD0 to AD15	Hi-Z							Active			Active		
ASTB	н							Active			Active		
R/W	н								Active Active				
DSTB	н							H Active					
LBEN	Н							Active			Active		
UBEN	Н							Active			Active		
WAIT	Invalid Maskable Mask			Maskab	le								
HLDRQ	Maskable						Maskable Maskable Maskable			le			
HLDAK	H or L							H or L			H or L		
WRL	н							н			н		Note
WRH	н							н			Note		
RD	н	Н									Note		Н

Table 4-1. Bus Interface Pin Operation List (2/2) (b) During run

Note Active

- Remarks 1. F: Fetch
 - R: Read
 - W: Write
 - 2. H: High-level output
 - L: Low-level output
 - Hi-Z: High-impedance

APPENDIX PACKAGE DRAWINGS



IE-703002-MC + IE-703037-MC-EM1 (Unit: mm)

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